

CMOS Digital Integrated Circuits Silicon Monolithic

## TC7SZ126AFS

#### 1. Functional Description

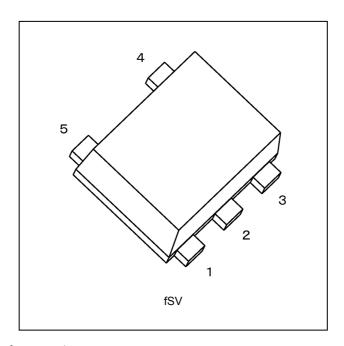
• Bus Buffer with 3-State Output

#### 2. Features

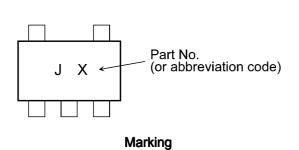
- (1) Wide operating temperature range:  $T_{opr} = -40$  to 125 °C (Note 1)
- (2) High output current:  $\pm 24$  mA (min) at  $V_{CC} = 3.0$  V
- (3) Super high speed operation:  $t_{pd} = 2.6$  ns (typ.) at  $V_{CC} = 5.0$  V,  $C_L = 50$  pF
- (4) Operation voltage range:  $V_{CC} = 1.65$  to 5.5 V
- (5) 5.5 V tolerant inputs

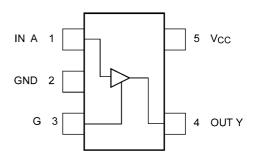
Note 1: For devices with the ordering part number ending in J(T. Topr = -40 to 85 °C for the other devices.

#### 3. Packaging



## 4. Marking and Pin Assignment





Pin Assignment (Top view)

Start of commercial production



### 5. IEC Logic Symbol



## 6. Truth Table

Input A	Input G	Output Y
Х	L	Z
L	Н	L
Н	Н	Н

X: Don't care

Z: High impedance

## 7. Absolute Maximum Ratings (Note) (Unless otherwise specified, T<sub>a</sub> = 25 °C)

Characteristics	Symbol	Note	Rating	Unit
Supply voltage	$V_{CC}$		-0.5 to 6.0	V
Input voltage	V <sub>IN</sub>		-0.5 to 6.0	V
DC output voltage	V <sub>OUT</sub>		-0.5 to V <sub>CC</sub> + 0.5	V
Input diode current	I <sub>IK</sub>		-20	mA
Output diode current	I <sub>OK</sub>	(Note 1)	±20	mA
DC output current	l <sub>out</sub>		±50	mA
V <sub>CC</sub> /ground current	I <sub>CC</sub>		±50	mA
Power dissipation	$P_D$		50	mW
Storage temperature	T <sub>stg</sub>		-65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: V<sub>OUT</sub> < GND, V<sub>OUT</sub> > V<sub>CC</sub>



## 8. Operating Ranges (Note)

Characteristics	Symbol	Note	Test Condition	Rating	Unit
Supply voltage	V <sub>CC</sub>		_	1.65 to 5.5	V
		(Note 1)	_	1.5 to 5.5	
Input voltage	V <sub>IN</sub>		_	0 to 5.5	V
Output voltage	V <sub>OUT</sub>		_	0 to V <sub>CC</sub>	V
Operating temperature	T <sub>opr</sub>	(Note 2)	_	-40 to 125	°C
		(Note 3)	_	-40 to 85	
Input rise and fall time	dt/dv		$V_{CC}$ = 1.8 $\pm$ 0.15 V, 2.5 $\pm$ 0.2 V	0 to 20	ns/V
			$V_{CC}$ = 3.3 $\pm$ 0.3 $V$	0 to 10	
			$V_{CC}$ = 5.0 ± 0.5 V	0 to 5	

Note: The operating ranges must be maintained to ensure the normal operation of the device.

Unused inputs must be tied to either V<sub>CC</sub> or GND.

Note 1: Data retention only

Note 2: For devices with the ordering part number ending in J(T.

Note 3: For devices except those with the ordering part number ending in J(T.

#### 9. Electrical Characteristics

## 9.1. DC Characteristics (Unless otherwise specified, T<sub>a</sub> = 25 °C)

Characteristics	Symbol	Test Condition		V <sub>CC</sub> (V)	Min	Тур.	Max	Unit
High-level input voltage	V <sub>IH</sub>	_		1.65 to 1.95	$V_{CC} \times 0.75$		_	V
				2.3 to 5.5	$V_{CC} \times 0.7$	_	_	
Low-level input voltage	V <sub>IL</sub>	_		1.65 to 1.95	-	_	$V_{CC} \times 0.25$	V
				2.3 to 5.5		-	$V_{CC} \times 0.3$	
High-level output voltage	V <sub>OH</sub>	$V_{IN} = V_{IH}$	I <sub>OH</sub> = -100 μA	1.65	1.55	1.65	_	V
				2.3	2.2	2.3	_	
				3.0	2.9	3.0	_	
				4.5	4.4	4.5	_	
			I <sub>OH</sub> = -4 mA	1.65	1.29	1.52	_	
			I <sub>OH</sub> = -8 mA	2.3	1.9	2.15	_	
			I <sub>OH</sub> = -16 mA	3.0	2.4	2.8	_	
			I <sub>OH</sub> = -24 mA	3.0	2.3	2.68	_	
			I <sub>OH</sub> = -32 mA	4.5	3.8	4.2	_	
Low-level output voltage	V <sub>OL</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OL</sub> = 100 μA	1.65		0.0	0.1	V
				2.3		0.0	0.1	
				3.0	_	0.0	0.1	
				4.5	_	0.0	0.1	
			I <sub>OL</sub> = 4 mA	1.65		0.08	0.24	
			I <sub>OL</sub> = 8 mA	2.3	_	0.1	0.3	
			I <sub>OL</sub> = 16 mA	3.0	_	0.15	0.4	
			I <sub>OL</sub> = 24 mA	3.0	_	0.22	0.55	
			I <sub>OL</sub> = 32 mA	4.5	_	0.22	0.55	
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = 5.5 V or GND		0 to 5.5	_	_	±1	μА
3-state output OFF-state leakage current	I <sub>OZ</sub>	$V_{IN} = V_{IH} \text{ or } V_{IL}$ $V_{OUT} = 0 \text{ to } 5.5 \text{ V}$	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>		_		±1	μА
Quiescent supply current	I <sub>CC</sub>	V <sub>IN</sub> = 5.5 V or GND		5.5	_	-	2	μА



## 9.2. DC Characteristics (Unless otherwise specified, $T_a = -40$ to 85 °C)

Characteristics	Symbol	Test Conditio	n	V <sub>CC</sub> (V)	Min	Max	Unit
High-level input voltage	V <sub>IH</sub>	_		1.65 to 1.95	V <sub>CC</sub> × 0.75	_	V
				2.3 to 5.5	$V_{CC} \times 0.7$	_	
Low-level input voltage	V <sub>IL</sub>	_		1.65 to 1.95		V <sub>CC</sub> × 0.25	V
				2.3 to 5.5	_	V <sub>CC</sub> × 0.3	
High-level output voltage	V <sub>OH</sub>	V <sub>IN</sub> = V <sub>IH</sub>	I <sub>OH</sub> = -100 μA	1.65	1.55	_	V
				2.3	2.2	_	
				3.0	2.9	_	
				4.5	4.4	_	
			I <sub>OH</sub> = -4 mA	1.65	1.29	_	
			I <sub>OH</sub> = -8 mA	2.3	1.9	_	V
			I <sub>OH</sub> = -16 mA	3.0	2.4	_	
			I <sub>OH</sub> = -24 mA	3.0	2.3	_	
			I <sub>OH</sub> = -32 mA	4.5	3.8	_	
Low-level output voltage	V <sub>OL</sub>	$V_{IN} = V_{IH}$ or $V_{IL}$	I <sub>OL</sub> = 100 μA	1.65		0.1	V
				2.3	_	0.1	
				3.0	_	0.1	
				4.5	_	0.1	
			I <sub>OL</sub> = 4 mA	1.65	_	0.24	
			I <sub>OL</sub> = 8 mA	2.3	_	0.3	
			I <sub>OL</sub> = 16 mA	3.0	_	0.4	
			I <sub>OL</sub> = 24 mA	3.0	_	0.55	
			I <sub>OL</sub> = 32 mA	4.5	_	0.55	
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = 5.5 V or GND		0 to 5.5	_	±10	μΑ
3-state output OFF-state leakage current	I <sub>OZ</sub>	$V_{IN} = V_{IH} \text{ or } V_{IL}$ $V_{OUT} = 0 \text{ to } 5.5 \text{ V}$		1.65 to 5.5		±10	μА
Quiescent supply current	Icc	V <sub>IN</sub> = 5.5 V or GND		5.5	_	20	μΑ



## 9.3. DC Characteristics (Note) (Unless otherwise specified, T<sub>a</sub> = -40 to 125 °C)

Characteristics	Symbol	Test Condition		V <sub>CC</sub> (V)	Min	Max	Unit
High-level input voltage	V <sub>IH</sub>	_		1.65 to 1.95	V <sub>CC</sub> × 0.75	_	V
				2.3 to 5.5	V <sub>CC</sub> × 0.7	_	
Low-level input voltage	V <sub>IL</sub>	_	,	1.65 to 1.95	_	V <sub>CC</sub> × 0.25	V
				2.3 to 5.5	_	V <sub>CC</sub> × 0.3	
High-level output voltage	V <sub>OH</sub>	$V_{IN} = V_{IH}$	I <sub>OH</sub> = -100 μA	1.65	1.55	_	V
				2.3	2.2	_	
				3.0	2.9	_	
				4.5	4.4	_	
			$I_{OH} = -4 \text{ mA}$	1.65	0.95	_	
			$I_{OH}$ = -8 mA	2.3	1.7	_	
			I <sub>OH</sub> = -16 mA	3.0	2.2	_	
			I <sub>OH</sub> = -24 mA	3.0	2.0	_	
			I <sub>OH</sub> = -32 mA	4.5	3.4	_	
Low-level output voltage	V <sub>OL</sub>	$V_{IN} = V_{IH}$ or $V_{IL}$	I <sub>OL</sub> = 100 μA	1.65	_	0.1	V
				2.3	_	0.1	
				3.0	_	0.1	
				4.5	_	0.1	
			I <sub>OL</sub> = 4 mA	1.65	_	0.7	
			I <sub>OL</sub> = 8 mA	2.3	_	0.45	
			I <sub>OL</sub> = 16 mA	3.0	_	0.6	
			I <sub>OL</sub> = 24 mA	3.0	_	0.8	
			I <sub>OL</sub> = 32 mA	4.5	_	0.8	
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = 5.5 V or GND		0 to 5.5	_	±20	μΑ
3-state output OFF-state leakage current	I <sub>OZ</sub>	$V_{IN} = V_{IH} \text{ or } V_{IL}$ $V_{OUT} = 0 \text{ to } 5.5 \text{ V}$		1.65 to 5.5	_	±20	μА
Quiescent supply current	Icc	V <sub>IN</sub> = 5.5 V or GND		5.5	_	200	μА

Note: For devices with the ordering part number ending in J(T.



## 9.4. AC Characteristics (Unless otherwise specified, $T_a = 25$ °C, Input: $t_f = t_f = 3$ ns)

Characteristics	Symbol	Note	Test Condition	V <sub>CC</sub> (V)	C <sub>L</sub> (pF)	Min	Тур.	Max	Unit
Propagation delay time	$t_{PLH}, t_{PHL}$		$R_L = 1 M\Omega$	$1.8 \pm 0.15$	15	2.0	5.3	13.0	ns
			See 9.7 AC Test Circuit, Table 9.7.1	$2.5\pm0.2$		8.0	3.4	7.5	
			Circuit, Table 9.7.1	$3.3\pm0.3$		0.5	2.5	5.2	
				5.0 ± 0.5		0.5	2.1	4.5	
			$R_L = 500 \Omega$	$3.3\pm0.3$	50	1.5	3.2	5.7	ns
			See 9.7 AC Test Circuit, Table 9.7.1	$5.0 \pm 0.5$		8.0	2.6	5.0	
Output enable time	$t_{PZL}, t_{PZH}$		R <sub>L</sub> = 500 Ω	$1.8\pm0.15$	50	2.0	8.0	14.5	ns
			See 9.7 AC Test Circuit, Table 9.7.1	$2.5\pm0.2$		1.5	4.6	8.5	
			Olicult, Table 9.7.1	$3.3\pm0.3$		1.5	3.5	6.2	
				$5.0\pm0.5$		8.0	2.8	5.5	
Output disable time	$t_{PLZ}, t_{PHZ}$		R <sub>L</sub> = 500 Ω	$1.8 \pm 0.15$	50	2.0	7.0	13.0	ns
			See 9.7 AC Test Circuit, Table 9.7.1	$2.5\pm0.2$		1.5	3.5	8.0	
			Circuit, Table 9.7.1	$3.3\pm0.3$		1.0	2.8	5.7	
				$5.0 \pm 0.5$		0.5	2.1	4.7	
Input capacitance	C <sub>IN</sub>		_	0 to 5.5			4		pF
Output capacitance	C <sub>OUT</sub>		_	0 to 5.5	_	_	4	_	pF
Power dissipation	C <sub>PD</sub>	(Note 1)	_	3.3			12		pF
capacitance				5.5		_	22	_	

Note 1:  $C_{PD}$  is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation.  $I_{CC(opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}$ 

# 9.5. AC Characteristics (Unless otherwise specified, $T_a = -40$ to 85 °C, Input: $t_r = t_f = 3$ ns)

Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	C <sub>L</sub> (pF)	Min	Max	Unit						
Propagation delay time	t <sub>PLH</sub> ,t <sub>PHL</sub>	$R_L = 1 M\Omega$	$1.8 \pm 0.15$	15	2.0	13.5	ns						
		See 9.7 AC Test Circuit, Table 9.7.1	$2.5\pm0.2$		8.0	8.0							
		Table 9.7.1	$3.3 \pm 0.3$		0.5	5.5							
			$5.0 \pm 0.5$		0.5	4.8							
		$R_L = 500 \Omega$	$3.3 \pm 0.3$	50	1.5	6.0	ns						
		See 9.7 AC Test Circuit, Table 9.7.1	$5.0 \pm 0.5$		8.0	5.3							
Output enable time	$t_{PZL},t_{PZH}$	$t_{PZL}, t_{PZH}$ R <sub>L</sub> = 500 $\Omega$ See 9.7 AC Test Circuit, Table 9.7.1	$1.8\pm0.15$	50	2.0	15.0	ns						
			$2.5\pm0.2$		1.5	9.0							
	1					.	Table 9.7.1	Table 5.7.1	$3.3 \pm 0.3$		1.5	6.5	
			$5.0 \pm 0.5$		8.0	5.8							
Output disable time	$t_{PLZ}, t_{PHZ}$	R <sub>L</sub> = 500 Ω	$1.8\pm0.15$	50	2.0	13.5	ns						
					See 9.7 AC Test Circuit, Table 9.7.1	$2.5\pm0.2$		1.5	8.5				
		Table 5.7.1	$3.3 \pm 0.3$		1.0	6.0							
			$5.0 \pm 0.5$		0.5	5.0							



## 9.6. AC Characteristics (Note) (Unless otherwise specified, $T_a = -40$ to 125 °C, Input: $t_r = t_f = 3$ ns)

Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	C <sub>L</sub> (pF)	Min	Max	Unit		
Propagation delay time	t <sub>PLH</sub> ,t <sub>PHL</sub>	$R_L = 1 M\Omega$	1.8 ± 0.15	15	2.0	15.0	ns		
		See 9.7 AC Test Circuit, Table 9.7.1	$2.5\pm0.2$		0.8	9.0			
		Table 9.7.1	$3.3 \pm 0.3$		0.5	6.5			
			$5.0 \pm 0.5$		0.5	5.5			
		$R_L$ = 500 $Ω$ See 9.7 AC Test Circuit,	$3.3 \pm 0.3$	50	1.5	7.0	ns		
		Table 9.7.1	$5.0 \pm 0.5$		0.8	6.0			
Output enable time	$t_{PZL}, t_{PZH}$	$t_{PZL}, t_{PZH}$ R <sub>L</sub> = 500 $\Omega$ See 9.7 AC Test Circuit, Table 9.7.1	$1.8 \pm 0.15$	50	2.0	16.5	ns		
			· ·	1 '1	$2.5\pm0.2$		1.5	10.0	
					$3.3 \pm 0.3$		1.5	7.5	
			$5.0 \pm 0.5$		0.8	6.5			
Output disable time	$t_{PLZ}, t_{PHZ}$	R <sub>L</sub> = 500 Ω	1.8 ± 0.15	50	2.0	15.0	ns		
		I I	I : I	See 9.7 AC Test Circuit, Table 9.7.1	$2.5\pm0.2$		1.5	9.5	
		Table 9.7.1			1.0	7.0			
			$5.0 \pm 0.5$		0.5	5.5			

Note: For devices with the ordering part number ending in J(T.

### 9.7. AC Test Circuit

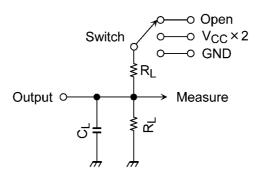


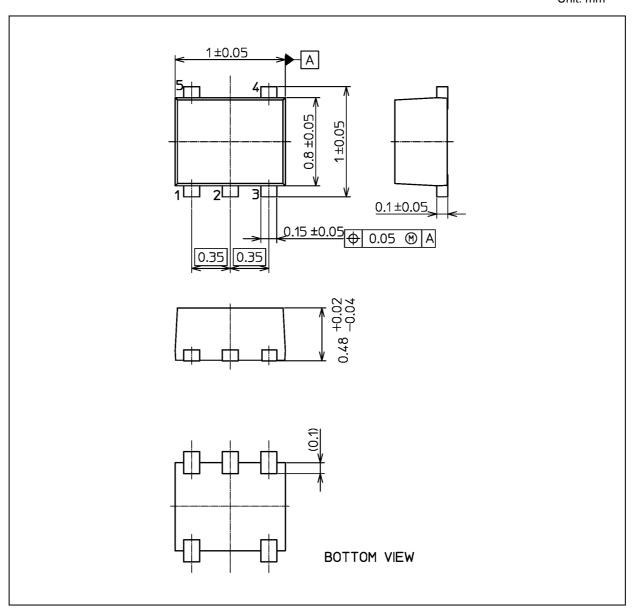
Table 9.7.1 Parameter for AC Test Circuit

Characteristics	Switch
t <sub>PLH</sub> , t <sub>PHL</sub>	Open
t <sub>PLZ</sub> , t <sub>PZL</sub>	V <sub>CC</sub> × 2
t <sub>PHZ</sub> , t <sub>PZH</sub>	GND



## **Package Dimensions**

Unit: mm



Weight: 1.0 mg (typ.)

	Package Name(s)
JEDEC: SOT-953	
Nickname: fSV	



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